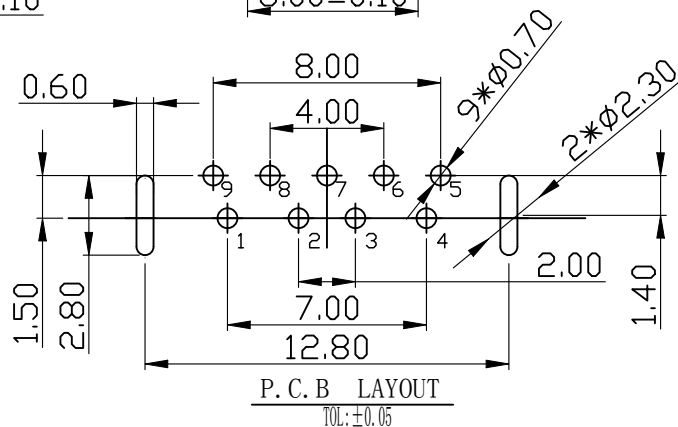
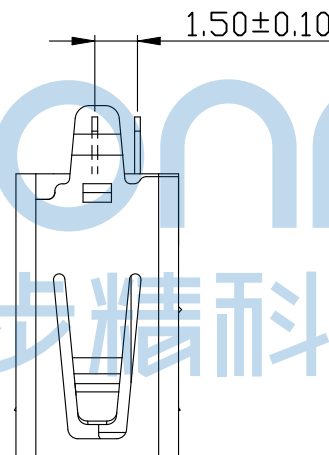
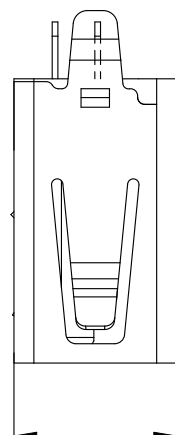
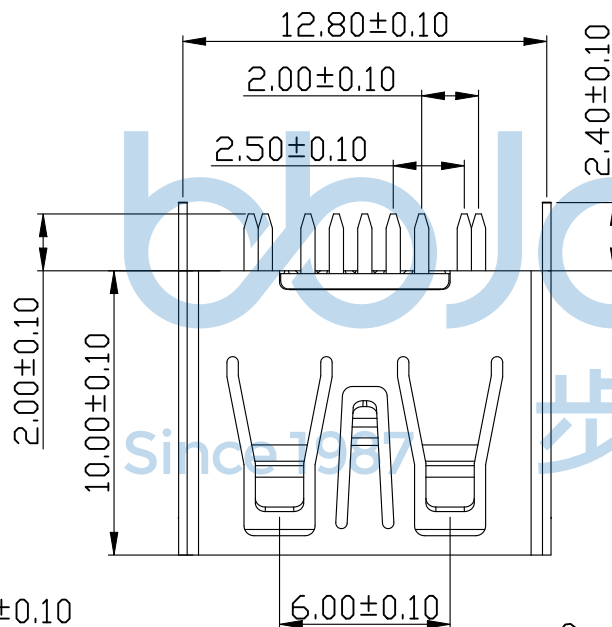
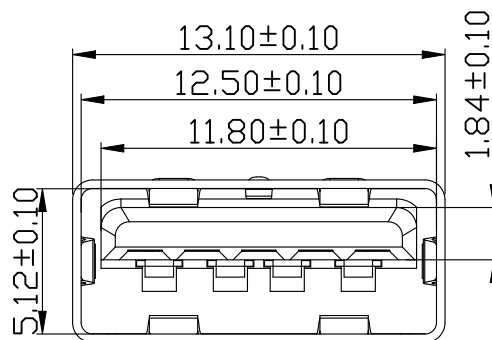




REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP

NOTE:

1. MATERIAL:

- 1.1 INSULATOR: PBT & PA9T & LCP
- 1.2 CONTACT: COPPER ALLOY C5191
- 1.3 SHELL: SUS201 SPCC

2. ELECTRICAL CHARACTERISTICS:

- 2.1 CONTACT RESISTANCE: 30mΩ MAXIMUM
- 2.2 CONTACT CURRENT RATING: 1.5A
- 2.3 DIELECTRIC WITHSTANDING VOLTAGE: 100 V R.M.S.
- 2.4 INSULATION RESISTANCE 100 MEGOHMS MIN
- 2.5 OPERATING TEMPERATURE: -20° C ~ 60° C

3. PLATING

3.1 TERMINAL:

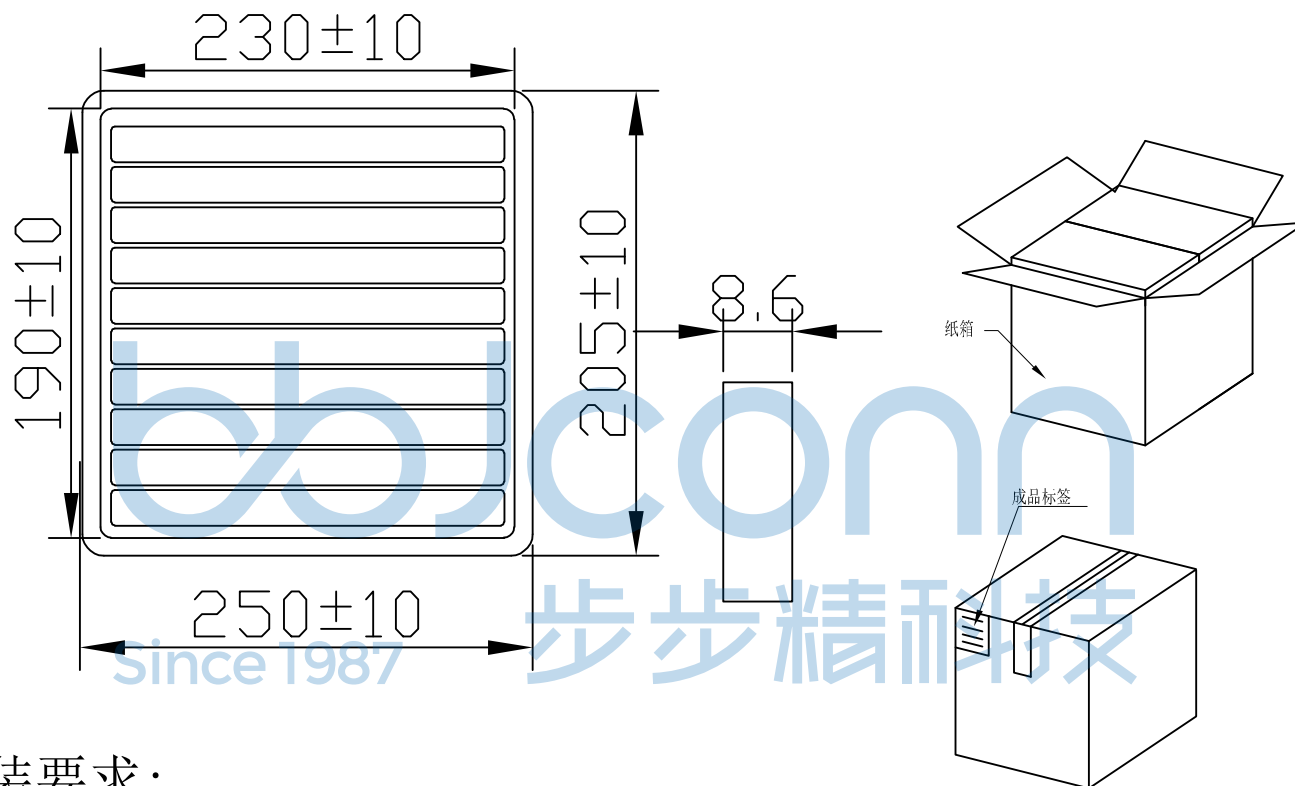
- 50u" MIN NICKEL ALL OVER
- 100u" MIN Tin ON SOLDER AREA
- (1~30)u" Au ON CONTACT AREA

3.2 SHELL: 80u" MIN. NICKEL ALL OVER



Pin NUMBER	SIGNAL NAME
1	VBUS
2	D-
3	D+
4	GND
5	StdA_SSRX-
6	StdA_SSRX+
7	GND_DRAIN
8	StdA_SSTX-
9	StdA_SSTX+
Shell	Shield

THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co., Ltd. Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.		深圳市步步精科技有限公司	
PDWG.NO: 0471-1	DR. TSP	.X: ±0.38 .XX: ±0.25 .XXX: ±0.13	NAME: USB 3.0 AF 180度 H=10.0 直脚 直插 端子DIP 平口 LCP蓝胶 铁壳 端子镀金15u
APPD. JM_Zheng	CHKD. LYX	PJ. NO.: 127-275-090003-Y4G SIZE: A4 DRW NO.:	
		FINISH: SEE NOTES	MAT'L.: SEE NOTES
		SCALE: N/A	REV.: A0 UNIT: mm PAGE: 1/2



1. 包装要求:
- 1.1 每盒吸塑盒包装100pcs;
 - 1.2 每20盘放一箱, 共计2000PCS;
 - 1.3 纸箱外贴上标签。

纸箱规格: 350*210*290

THIS DOCUMENT IS THE SOLE PROPERTY OF BBJconn Technology Co.,Ltd Corporation AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.		深圳市步步精科技有限公司	
PDWG.NO: 0471-1		NAME: USB 3.0 AF 180度 H=10.0 直脚 直插 端子DIP 平口 LCP蓝胶 铁壳 端子镀金15u	
APPD.	JM_Zheng	PJ. NO.:	127-275-090003-Y4G
CHKD.	LYX	SIZE: A4	DRW NO.:
DR.	TSP	FINISH: SEE NOTES	MAT'L.: SEE NOTES
		SCALE: N/A	REV.: A0
		UNIT: mm	PAGE: 2/2